
e-Diagnostics / e-Manufacturing Seminar

**16 April 2002
SEMICON Europa**

e-Diagnostics/e-Manufacturing - 4/16/2002

Agenda

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|-------|---|-------------|
| 08:30 | Welcome / Introduction | H. Wohlwend |
| 08:40 | <u>STMicroelectronics “e” Requirements</u> | R. Ronchi |
| 09:00 | <u>e-Diagnostics/e-Manufacturing Latest News</u> | H. Wohlwend |
| 09:20 | <u>EEC Update</u> | B. Van Eck |
| 09:40 | <u>e-Standards Task Forces – Goals and Status</u> | L. Rist |
| 10:00 | Break | |
| 10:20 | <u>Axeda - ISMT Prototyping Experiences</u> | G. Heath |
| 10:40 | <u>KLA-Tencor – Remote Collaboration</u> | M. Locy |
| 10:00 | <u>Applied Materials – Field Engineer Support</u> | K. Medberry |
| 11:20 | <u>Brooks Automation – APC in EEC</u> | N. Heller |
| 11:40 | Panel | All |
| 12:00 | <u>Closing Comments</u> | H. Wohlwend |

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e-Diagnostics/e-Manufacturing seminar

What: This seminar is an e-Diagnostics, EEC, and e-Manufacturing update. A summary of requirements and implementation guidelines will be provided as well as supplier implementation experiences. This meeting provides an opportunity to widely distribute the material to encourage consistent industry implementations.

When: 16 Apr 2002, 08:30am – 12:00noon

Who: Any interested chip manufacturers and suppliers

Why: To update interested IC Makers & equipment & software suppliers on the requirements for e-Diagnostics, EEC, and e-Manufacturing.

Where: ICM, Meese Munich, Germany

Expected Results: Further alignment of chip manufacturer and supplier implementation strategies for e-Diagnostics / EEC / e-Manufacturing and a common understanding of issues.

www.sematech.org/public/resources/ediag/index.htm